



S12ZVC Mixed-Signal MCU for Automotive and Industrial CAN Applications

S12ZVC

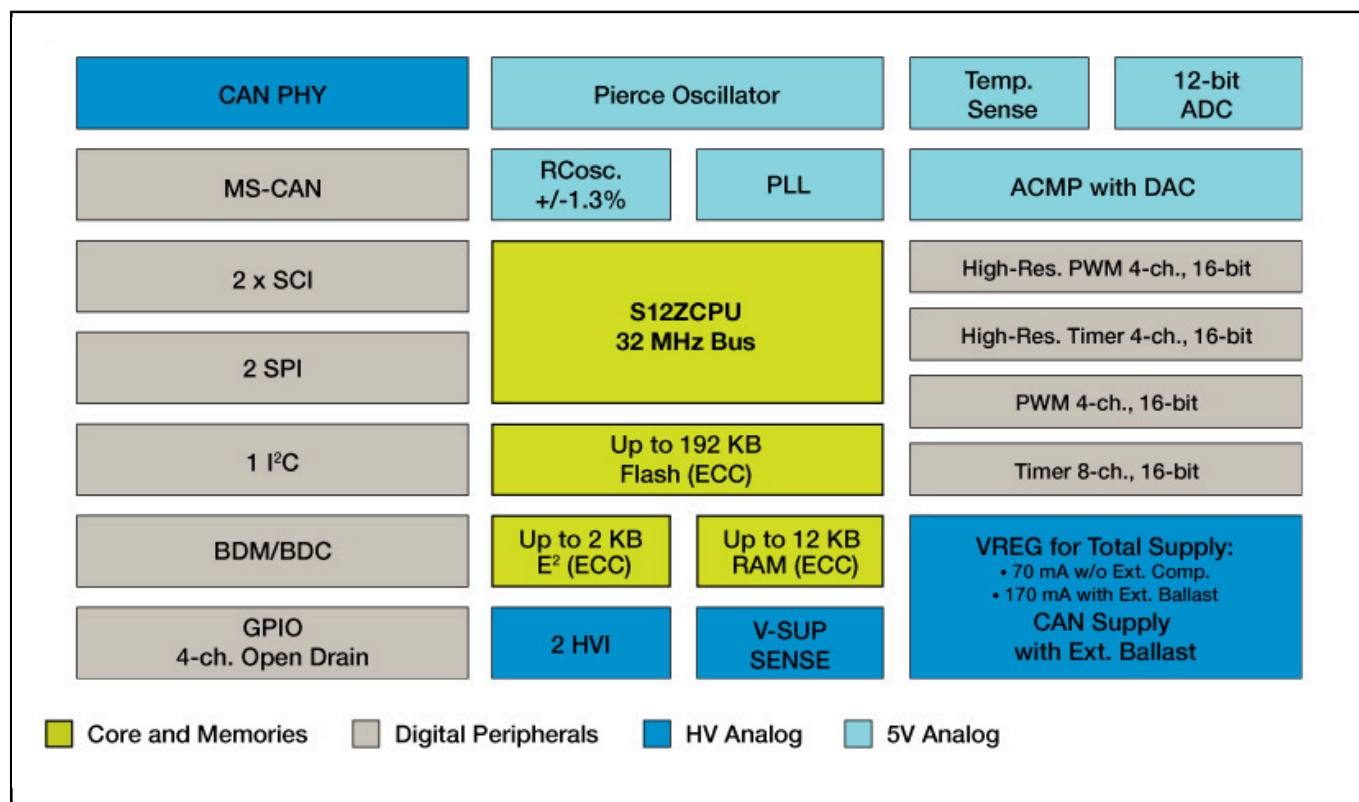
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The S12ZVC platform, part of the S12 MagniV® mixed-signal MCU family, offers a low-cost, highly integrated solution that enables the design of smallest possible automotive CAN-termination nodes, while the family concept gives you scalability for platform design.

The S12ZVC integrates a sophisticated S12Z core together with a 12 V to 5 V voltage regulator and a CAN physical layer for automotive and industrial applications such as sensors, actuators switch panels or other user interfaces.

For additional information and sample availability, contact your local [NXP Sales Office](#).

S12 MagniV Mixed-Signal MCU for CAN Applications Block Diagram



View additional information for [S12ZVC Mixed-Signal MCU for Automotive and Industrial CAN Applications](#).

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